

Power Resistors

Series MSP-35 SMD TO-220

35 W Thick Film Resistor for surface mount including Metal Tab

35 W Film Power Resistor for surface mount including metal tab.

Features

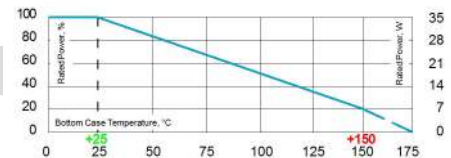
- 35 W operating power
- **SMD TO-220 package** configuration
- Molded case for environmental protection
- Resistor element is electrically insulated from the metal sink tab
- Non-Inductive design
- ROHS compliant
- Materials in accordance with UL 94 V-0



Technical Specifications

Resistance value	0.1 Ω \leq 1 M Ω (other values on special request)
Resistance tolerance	$\pm 10\%$ to $\pm 1\%$ $\pm 0.5\%$ on special request for limited ohmic values
Temperature coefficient	< 3 Ω : ask for details > 3 $\Omega \leq 10 \Omega$: ± 100 ppm + 0.002 $\Omega/^\circ\text{C}$ referenced to 25 $^\circ\text{C}$, ΔR taken at +85 $^\circ\text{C}$ > 10 Ω : ± 50 ppm/ $^\circ\text{C}$ referenced to 25 $^\circ\text{C}$, ΔR taken at +85 $^\circ\text{C}$
Power rating	35 W at 25 $^\circ\text{C}$ bottom case temperature
Maximum operating voltage	350 V
Dielectric strength voltage	1,800 V AC
Insulation resistance	> 10 G Ω at 1,000 V DC
Momentary overload	2x rated power with applied voltage not to exceed 1.5x maximum continuous operating voltage for 5 sec. $\Delta R \pm(0.3\% + 0.01 \Omega)$ max.
Load life	MIL-R-39009, 2,000 hours at rated power, $\Delta R \pm(1.0\% + 0.001 \Omega)$ max.
Moisture resistance	MIL-STD-202, method 106 $\Delta R = (0.5\% + 0.01 \Omega)$ max.
Thermal shock	MIL-STD-202, method 107, Cond. F, $\Delta R = (0.3\% + 0.01 \Omega)$ max.
Working temperature range	-55 $^\circ\text{C}$ to +175 $^\circ\text{C}$
Terminal strength	MIL-STD-202, method 211, Cond. A (Pull Test) 2.4 N, $\Delta R = (0.2\% + 0.01 \Omega)$ max.
Vibration, high frequency	MIL-STD-202, method 204, Cond. D, $\Delta R = (0.2\% + 0.01 \Omega)$ max.
Lead material	nickel-plated copper, dip-tinned
Ground plate material	german silver
Heat resistance to cooling plate	$R_{th} < 4.28 \text{ K/W}$
Weight	~1,4 g

Power Rating



Derating (thermal resist.) MSP-35:
0.23 W/K (4.28 K/W)

Case temperature must be used for definition of the applied power limit. Case temperature measurement must be done with a thermocouple contacting the center of the component mounted on the designed heat sink. Thermal grease should be applied properly.

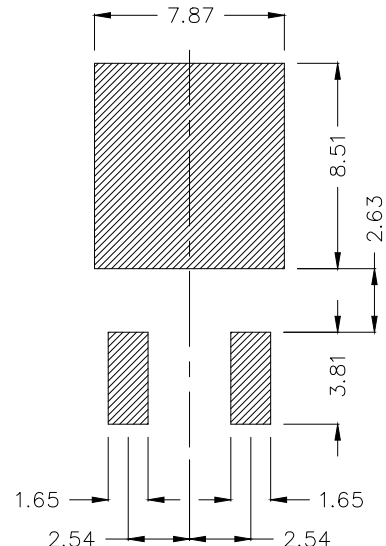
How to make a request

MSP_Ohmic Value_Tolerance

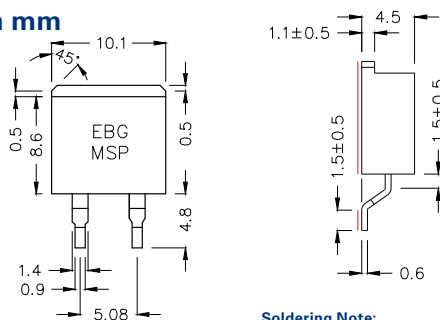
For example:
MSP 39R 5%

Higher solder profile:
MHP 560R 1%

Soldering Template



Dimensions in mm



Soldering Note:

During surface mount soldering, the soldering temperature profile must not cause the metal tab of this device to exceed 215 $^\circ\text{C}$.
If the solder profile is higher than 215 $^\circ\text{C}$ (up to 260 $^\circ\text{C}$), please use our alternative type **MHP-35 SMD TO-220**. Please contact us for further information!

Tolerances ± 0.2 unless otherwise noted!
TO 220 style power package for SMD applications
35 W power rating at 25 $^\circ\text{C}$ case temperature.

Flatness of ground plate to contacts <0.1mm

The above spec. sheet features our standard products. For further options please contact our local EBG representative or contact us directly.

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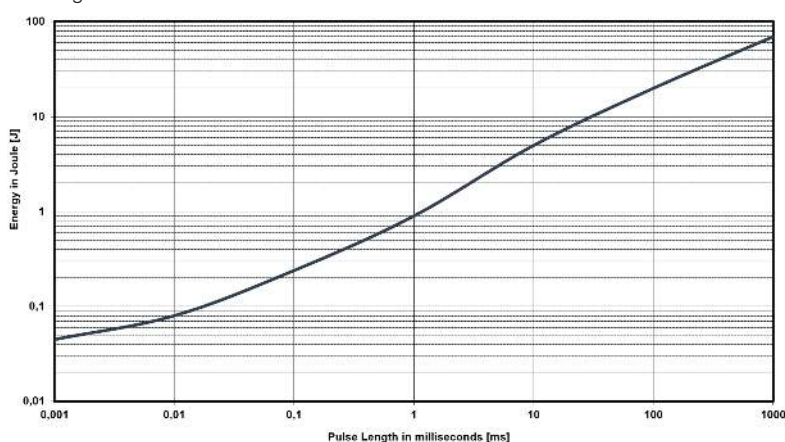
Pulse Energy Curve (typical rating for MSP-35)

Note: These energy values are reference values → depending on ohmic value e.g. 1 Ω to 10 Ω and used resistive paste, a variation in max. energy load capability is possible

Test procedure

Every test resistor was mounted with thermal compound (0.9 W/mK) on a water cooled heatsink

- Constant inlet water temperature: +50°C
- The test time of each tested resistor: 10min.
- Break time between two pulses: 1sec.
- To determine good / defect parts the ohmic value was measured before and after tests: a change of tolerance of more than 0.1% means defect



Description of Pulse Energy Curve

- Shape of pulse = e-function
- Time between two pulses = 1 second
- Pulse length = time constant of 1 tau (1 means ... tau = 1ms)

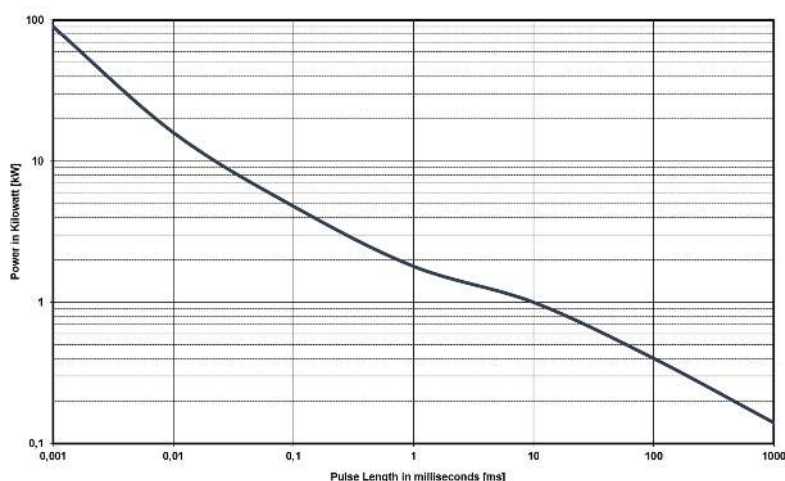
Example

At 1 ms tau the MSP-35 with e.g. 1 Ω to 10 Ω can withstand an energy level of about 0.9 J, when the pulse pause time is ≥ 1s

At a symmetrical frequency > 1 kHz at pulse length ≥ 10 μsec. the maximum applied pulse energy for MSP-35 is a result out of the nominal power 35 W divided by the operating frequency (at 25°C bottom case) ($E = 35 \text{ W} / F$)

Pulse Power Curve (typical rating for MSP-35)

The power curve shows the max. possible power which can be applied for a certain duration. Referring to the same test procedure as described above.



Description of Pulse Power Curve

- Shape of pulse = e-function
- Time between two pulses = 1 second
- Pulse length = time constant of 1 tau (1 means ... tau = 1ms)

Example

For the time-constant of 1 ms you can apply about 1.8 kW max., if the time between two such peaks is ≥ 1s